

Features

- Split Gate Trench MOSFET Technology
- Excellent Package For Heat Dissipation
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

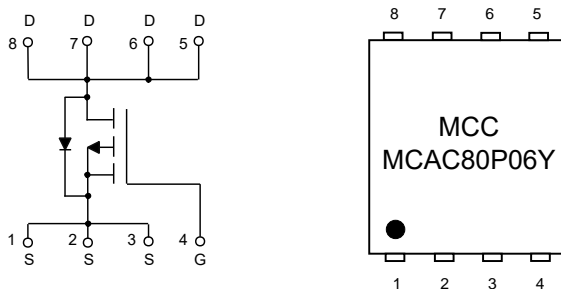
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient (Note2)
- Thermal Resistance: 1.04°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±18	V
Continuous Drain Current	I _D	T _C =25°C	-80
		T _C =100°C	-50
Pulsed Drain Current (Note3)	I _{DM}	-320	A
Total Power Dissipation (Note4)	P _D	120	W
Single Pulsed Avalanche Energy (Note5)	E _{AS}	400	mJ

Note:

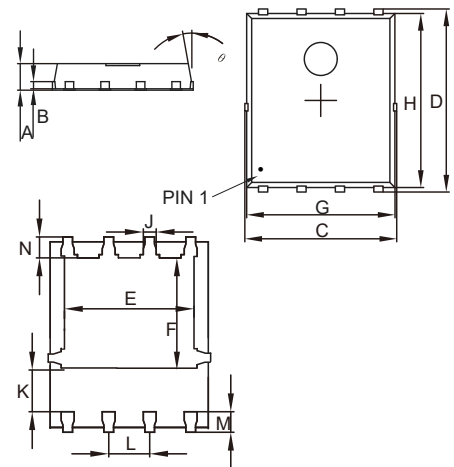
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
3. Pulse Test: Pulse Width≤300us, Duty cycle ≤2%.
4. Pd is based on max. junction temperature, using junction-case thermal resistance.
5. V_{DD}=-60V, R_G=25Ω, L=2mH, I_{AS}=-20A.

Internal Structure and Marking Code



P-CHANNEL MOSFET

DFN5060



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.031	0.047	0.80	1.20	
B	0.010		0.254		TYP.
C	0.193	0.222	4.90	5.64	
D	0.232	0.250	5.90	6.35	
E	0.148	0.167	3.75	4.25	
F	0.126	0.154	3.20	3.92	
G	0.189	0.213	4.80	5.40	
H	0.222	0.239	5.65	6.06	
K	0.045	0.059	1.15	1.50	
J	0.012	0.020	0.30	0.50	
L	0.046	0.054	1.17	1.37	
M	0.012	0.028	0.30	0.71	
N	0.016	0.028	0.40	0.71	

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-60			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 18V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-60V, V_{GS}=0V$			-1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-2	-2.7	-4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-20A$		6.1	8.0	m Ω
Gate Resistance	R_g	Drain open, f=1MHz		8		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				-80	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-20A$			-1.3	V
Reverse Recovery Time	t_{rr}	$I_S=-20A, di/dt=100A/\mu s$		57		ns
Reverse Recovery Charge	Q_{rr}			82		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=-30V, V_{GS}=0V, f=1MHz$		5300		pF
Output Capacitance	C_{oss}			960		
Reverse Transfer Capacitance	C_{rss}			36		
Total Gate Charge	Q_g	$V_{DS}=-30V, V_{GS}=-10V, I_D=-20A$		81		nC
Gate-Source Charge	Q_{gs}			19		
Gate-Drain Charge	Q_{gd}			18		
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=-30V, V_{GS}=-10V, R_G=1.6\Omega, I_D=-20A$		13.2		ns
Turn-On Rise Time	t_r			26		
Turn-Off Delay Time	$t_{d(off)}$			134.1		
Turn-Off Fall Time	t_f			58.9		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

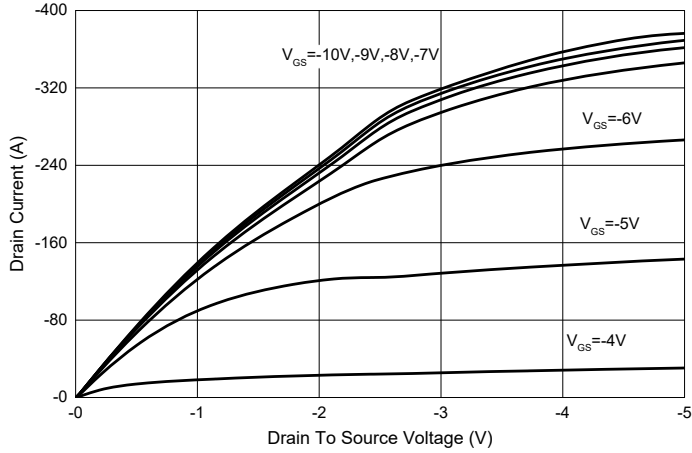


Fig. 2 - Transfer Characteristics

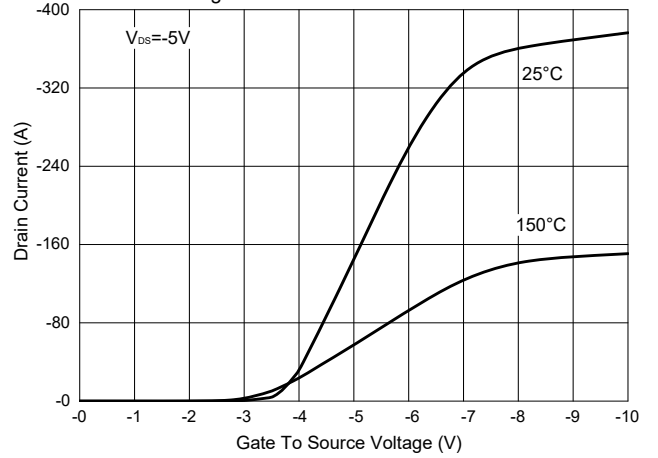


Fig. 3 - $R_{DS(ON)} - V_{GS}$

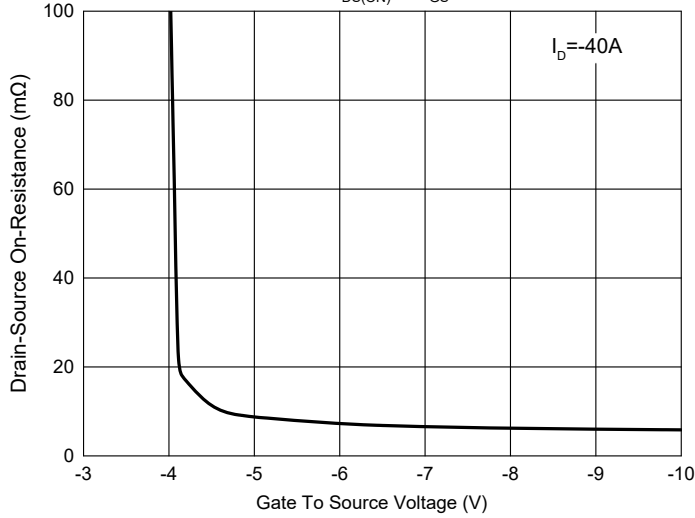


Fig. 4 - $R_{DS(ON)} - I_D$

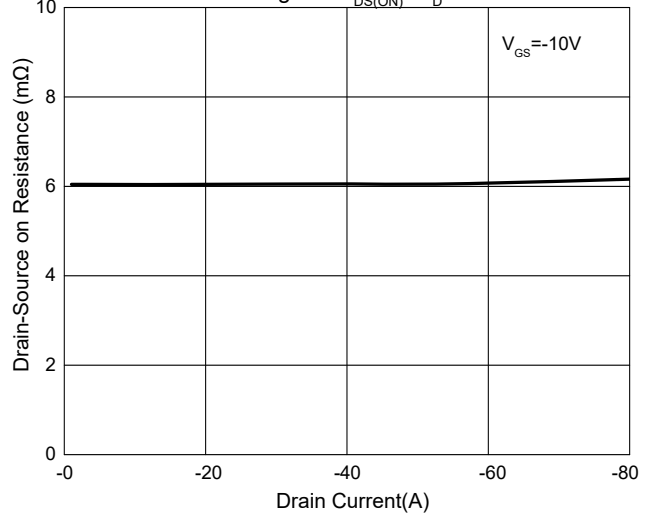


Fig. 5 - Capacitance Characteristics

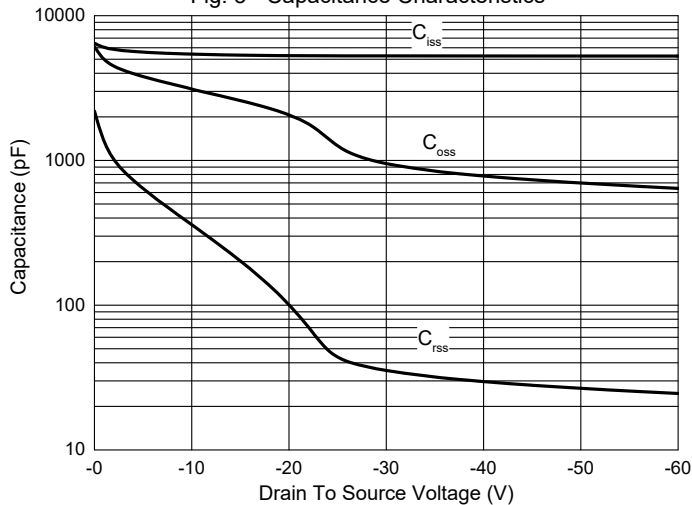
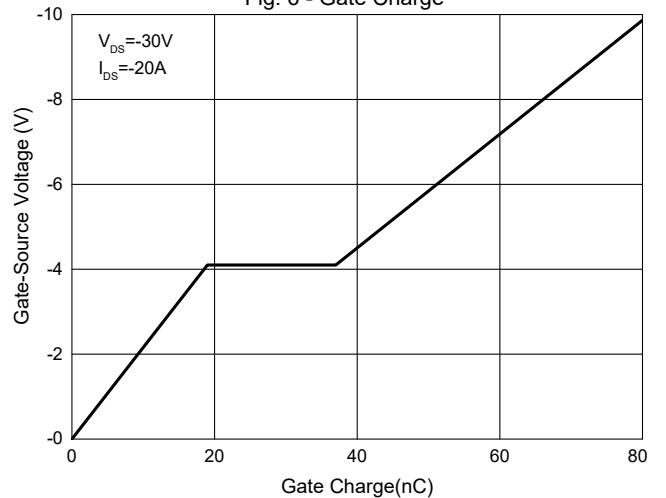


Fig. 6 - Gate Charge



Curve Characteristics

Fig. 7 - Normalized Threshold Voltage

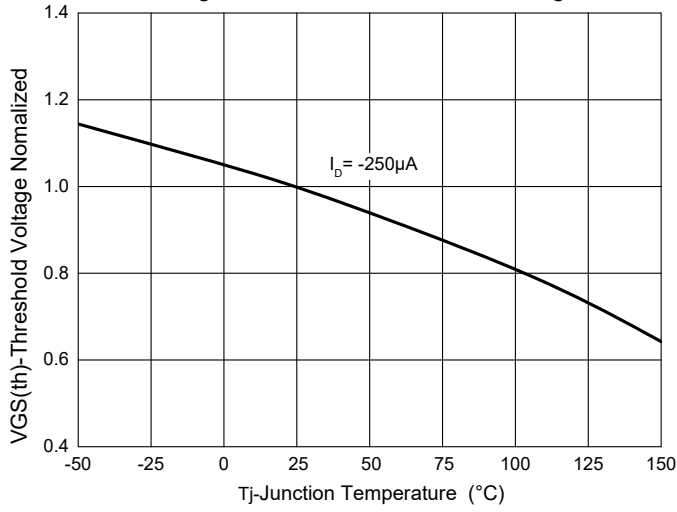


Fig. 8 - Normalized On Resistance Characteristics

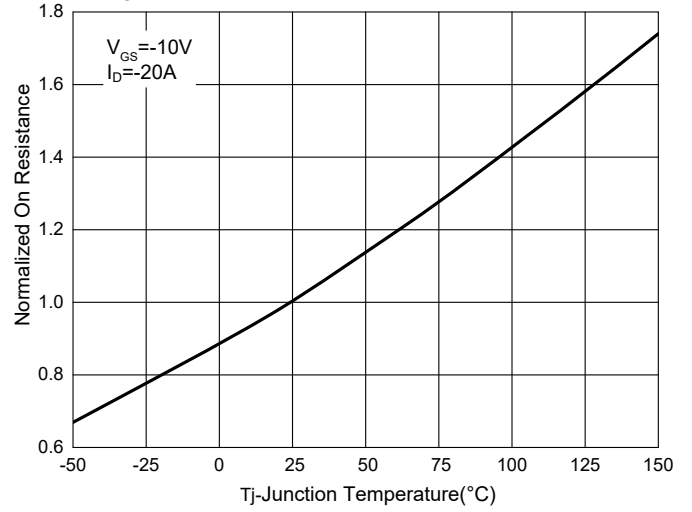


Fig. 9 - I_s - V_{SD}

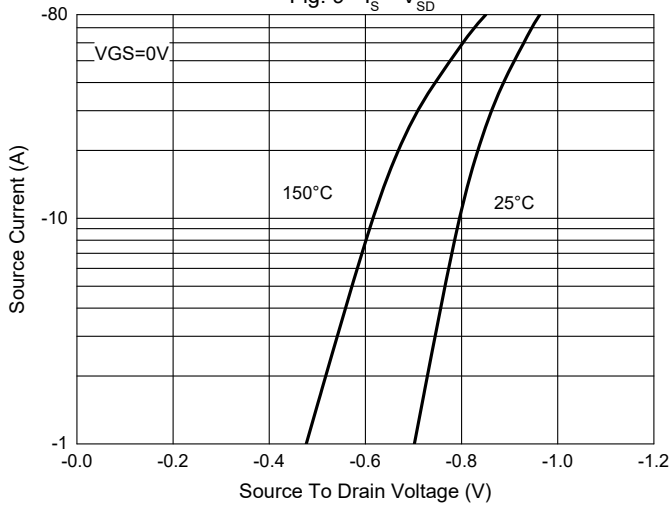


Fig. 10 - Drain Current

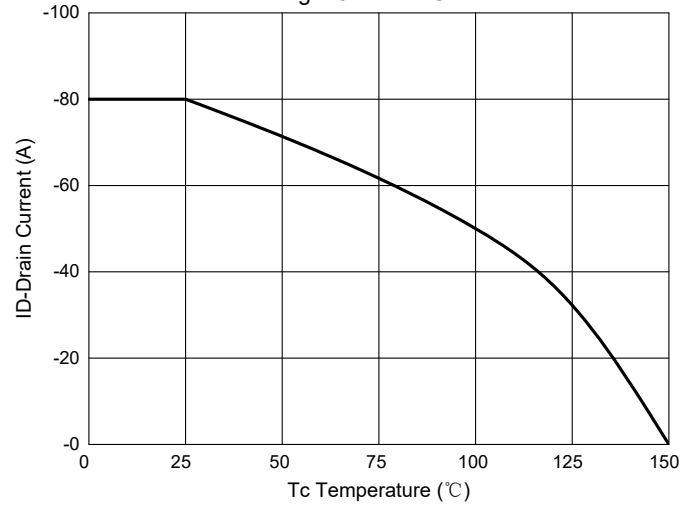
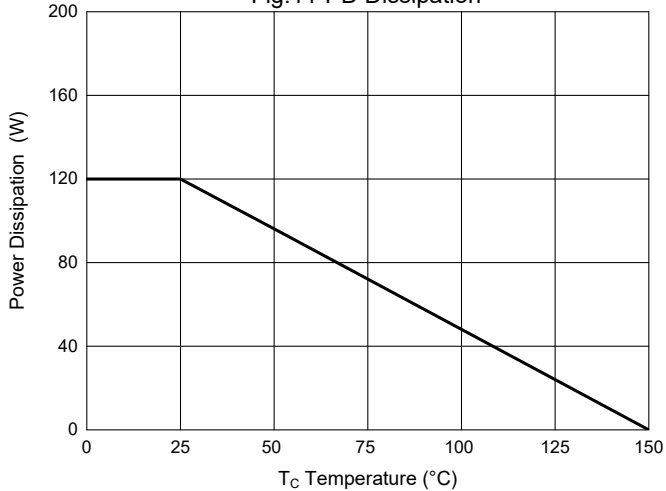


Fig. 11-PD Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

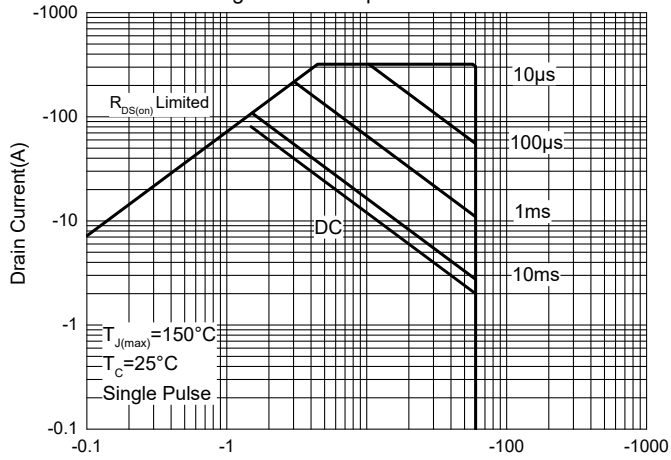
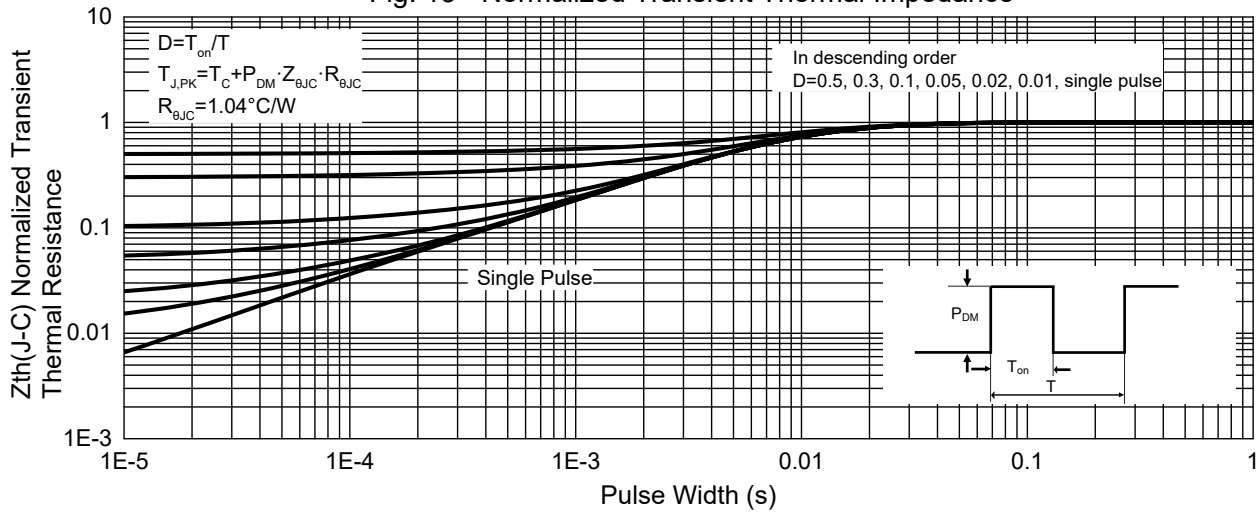


Fig. 13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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